

SEMICONDUCTOR®

November 2013

FQP11P06 P-Channel QFET[®] MOSFET -60 V, -11.4 A, 175 mΩ

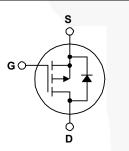
Description

These P-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology. This advanced technology has been especially tailored to minimize onstate resistance, provide superior switching performance, and withstand a high energy pulse in the avalanche and commutation modes. These devices are well suited for low voltage applications such as automotive, DC/DC converters, and high efficiency switching for power management in portable and battery operated products.

Features

- 11.4 A, -60 V, $R_{DS(on)}$ = 175 m Ω (Max.) @ V_{GS} = -10 V, I_{D} = -5.7 A
- Low Gate Charge (Typ. 13 nC)
- Low Crss (Typ. 45 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating





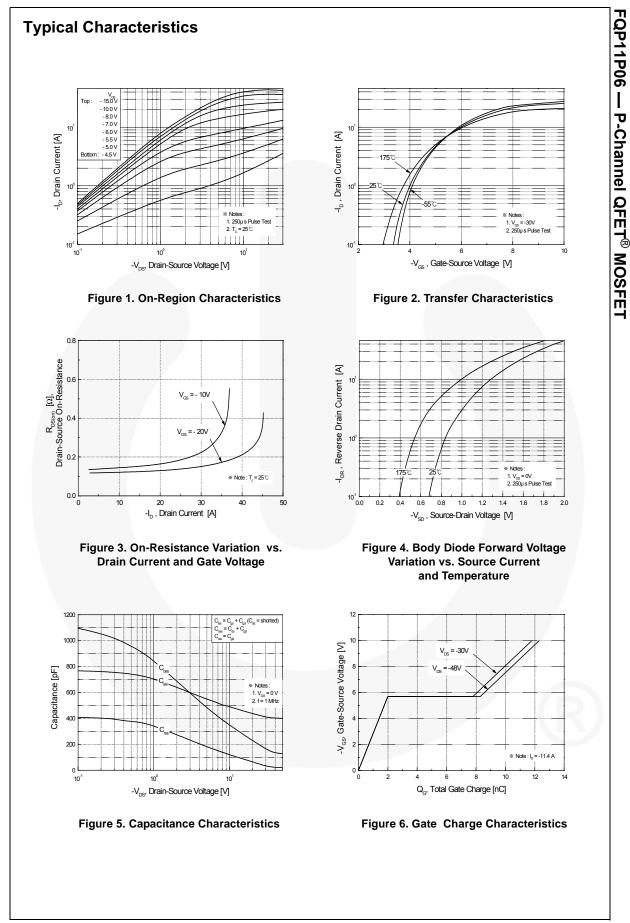
Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

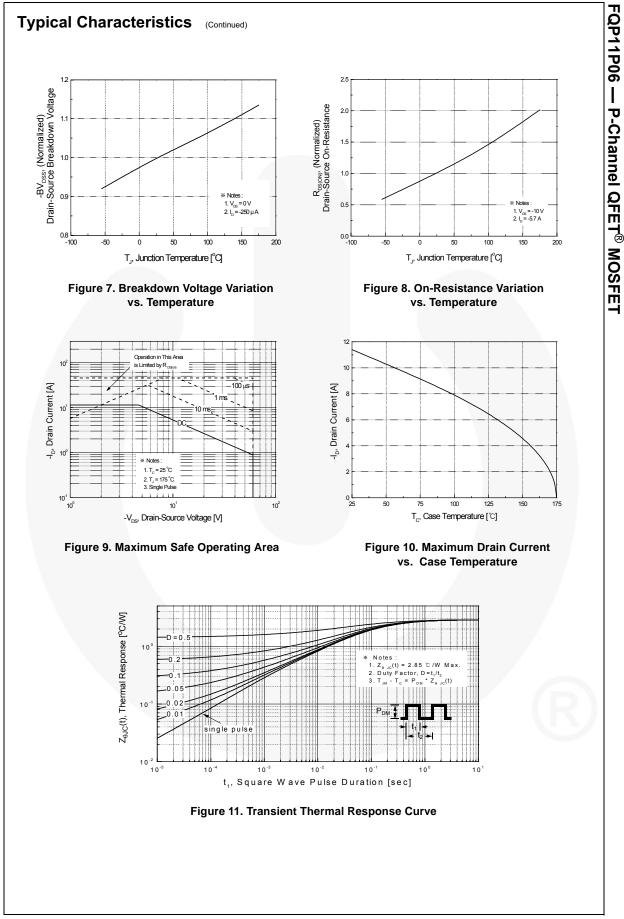
Symbol	Parameter		FQP11P06	Unit
V _{DSS}	Drain-Source Voltage		-60	V
I _D	Drain Current - Continuous (T _C = 25°	°C)	-11.4	A
	- Continuous (T _C = 100	-8.05	A	
I _{DM}	Drain Current - Pulsed	(Note 1)	-45.6	A
V _{GSS}	Gate-Source Voltage		± 25	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	160	mJ
I _{AR}	Avalanche Current	(Note 1)	-11.4	A
E _{AR}	Repetitive Avalanche Energy	(Note 1)	5.3	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	-7.0	V/ns
P _D	Power Dissipation ($T_C = 25^{\circ}C$)	53	W	
	- Derate above 25°C	0.35	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Ran	-55 to +175	°C	
TL	Maximum lead temperature for soldering 1/8" from case for 5 seconds	300	°C	

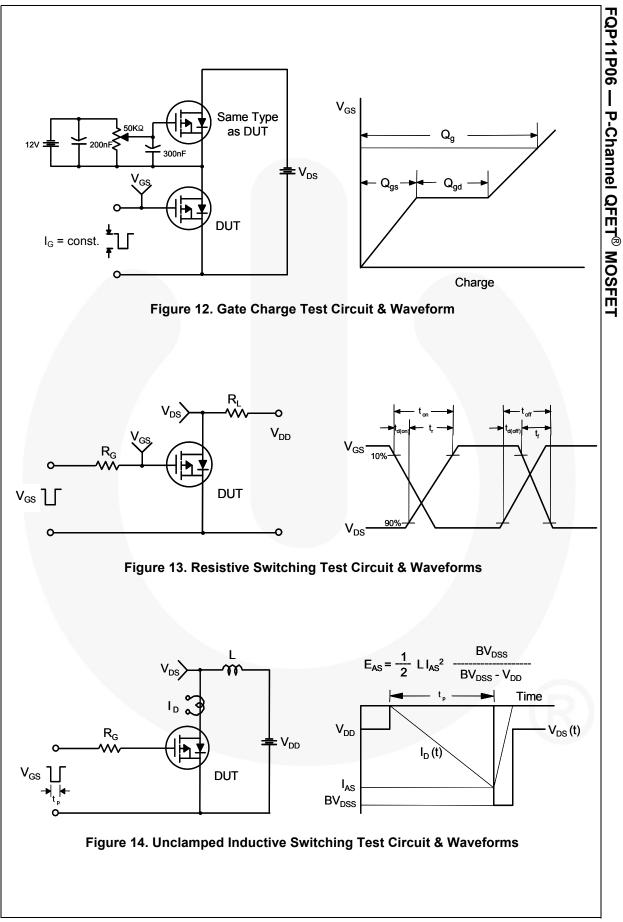
Thermal Characteristics

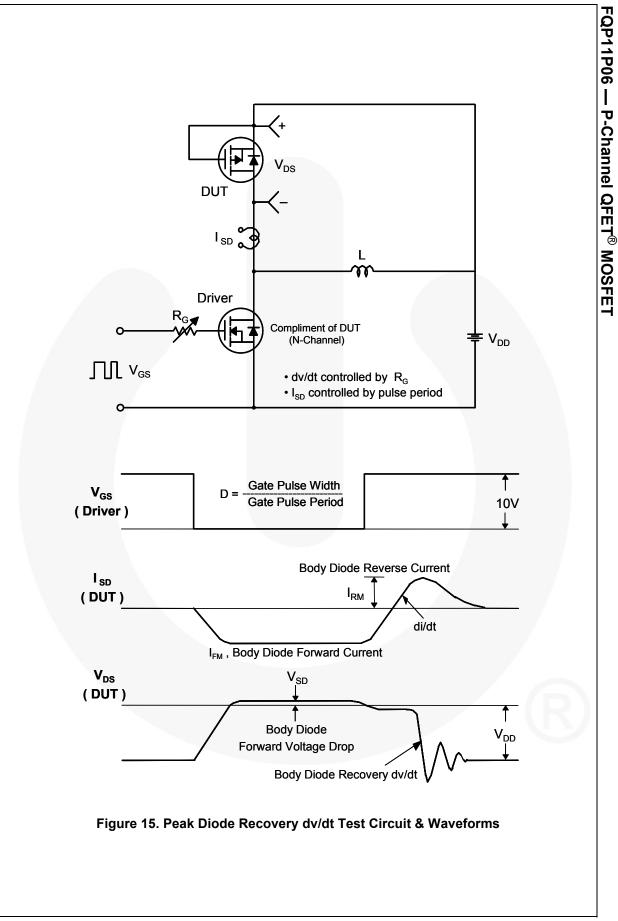
Symbol	Parameter	FQP11P06	Unit	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	2.85	°C/W	
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink, Typ.	0.5	°C/W	
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W	

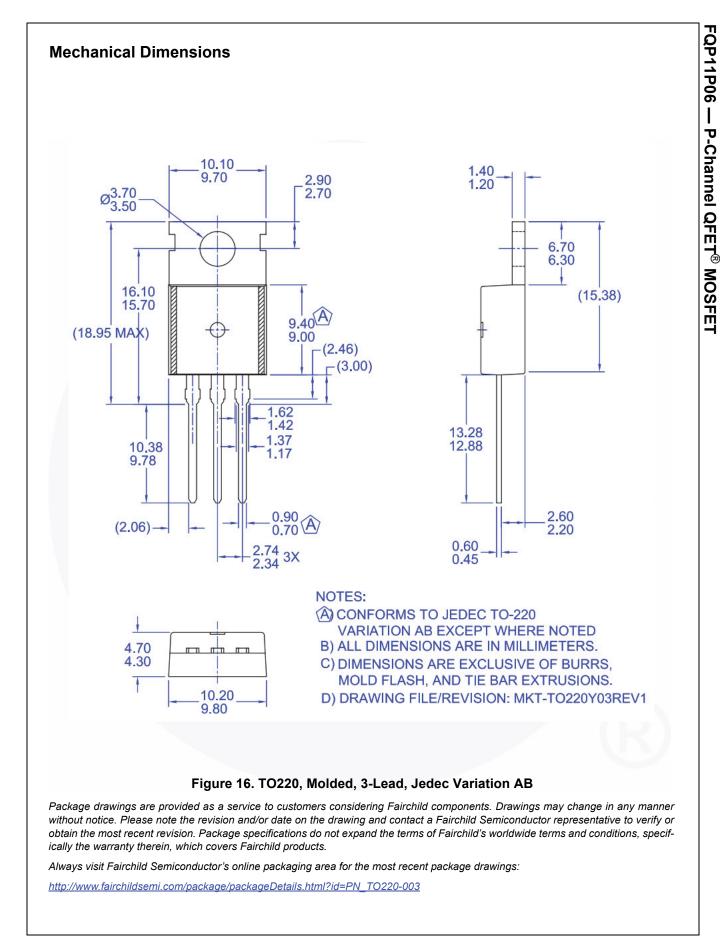
	mber	Top Mark	Pack	kage Packing Method		d Reel	Size	Tape W	idth	Quantity
FQP11	1P06 FQP11P06 TO		TO-2	-220 Tube N/		A	N/A		50 units	
lectri	cal Cł	naracteristics T	c = 25°C unle	ess otherw	vise noted.					
Symbol		Parameter			Test Conditions		Min	Тур	Max	Unit
Off Cha	ractori	etice								
BV _{DSS}		Source Breakdown Volta	ane	Vcs =	0 V, I _D = -250 μA		-60			V
ΔBV_{DSS}		own Voltage Temperatu	0				00			•
$/ \Delta T_{J}$	Coeffici		ii e	I_D = -250 μ A, Referenced to 25°C			-0.07		V/°C	
I _{DSS}	7			V _{DS} =	-60 V, V _{GS} = 0 V				-1	μA
	Zero Gate Voltage Drain Current		ent	V _{DS} =	-48 V, T _C = 150°C				-10	μA
I _{GSSF}	Gate-B	ody Leakage Current, F	orward	V _{GS} =	-25 V, V _{DS} = 0 V				-100	nA
I _{GSSR}	Gate-B	ody Leakage Current, F	Reverse	V _{GS} =	25 V, V _{DS} = 0 V				100	nA
On Cha	racteri	stics								
V _{GS(th)}	-	nreshold Voltage		V _{DS} =	V _{GS} , I _D = -250 μA		-2.0		-4.0	V
R _{DS(on)}		Static Drain-Source On-Resistance		V _{GS} =	-10 V, I _D = -5.7 A			0.14	0.175	Ω
9 _{FS}	Forwar	d Transconductance		V _{DS} =	-30 V, I _D = -5.7 A			5.1		S
								-	1	
-	1	acteristics							1	
C _{iss}	•	apacitance		V _{DS} = -25 V, V _{GS} = 0 V, f = 1.0 MHz				420	550	pF
C _{oss}		Capacitance					195	250	pF	
C _{rss}	Revers	e Transfer Capacitance	•					45	60	pF
Switchi	ing Cha	aracteristics								
t _{d(on)}		n Delay Time		- V _{DD} = -30 V, I _D = -5.7 A, R _G = 25 Ω			6.5	25	ns	
t _r	Turn-O	n Rise Time						40	90	ns
t _{d(off)}	Turn-O	ff Delay Time					15	40	ns	
t _f	Turn-O	ff Fall Time				(Note 4)		45	100	ns
Qg	Total G	ate Charge			-48 V, I _D = -11.4 A,			13	17	nC
Q _{gs}	Gate-S	ource Charge		$V_{GS} = -10 V$				2.0		nC
Q _{gd}	Gate-D	rain Charge		- 63		(Note 4)		6.3		nC
	4							4	1	/
Drain-S	ource	Diode Characteris	stics an	d Max	kimum Ratings					
I _S	Maximu	um Continuous Drain-S	ource Dio	de Forw	ard Current				-11.4	Α
I _{SM}	Maximu	Im Pulsed Drain-Source	e Diode F						-45.6	Α
V _{SD}	Drain-S	ource Diode Forward \	/oltage		0 V, I _S = -11.4 A				-4.0	V
t _{rr}	Revers	e Recovery Time			0 V, I _S = -11.4 A,			83	/	ns
Q _{rr}	Revers	e Recovery Charge		dl _F / dt	: = 100 A/μs			0.26		μC













Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.
		Rev. 166

QP11P06

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